

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	2	"382"/\$.ccls. and solder\$3 near3 paste same detect\$3 and printing and mounting	USPAT; EPO; JPO	OR	ON	2005/02/03 14:23
L3	1	"73"/\$.ccls. and solder\$3 near3 paste same detect\$3 and printing and mounting	USPAT; EPO; JPO	OR	ON	2005/02/03 14:24
L4	8	"228"/\$.ccls. and solder\$3 near3 paste same detect\$3 and printing and mounting	USPAT; EPO; JPO	OR	ON	2005/02/03 14:24
L5	6	29/830-845.ccls. and solder\$3 near3 paste same detect\$3 and printing and mounting	USPAT; EPO; JPO	OR	ON	2005/02/03 14:25
L6	4	29/720-740.ccls. and solder\$3 near3 paste same detect\$3 and printing and mounting	USPAT; EPO; JPO	OR	ON	2005/02/03 14:26
S2	2	S2/\$.ccls. and solder with (reference referring) same detect\$3 same (land pad) and print\$3 near position and mounting	USPAT; EPO; JPO	OR	ON	2004/04/02 13:52
S3	12	solder\$3 with (reference referring) same detect\$3 same (land pad) and print\$3 near position same detect\$3 and mounting	USPAT; EPO; JPO	OR	ON	2004/04/02 14:04
S4	2	solder\$3 with paste with (reference referring) and detect\$3 same (land pad) same print\$3 near position and mounting	USPAT; EPO; JPO	OR	ON	2004/04/02 14:11
S5	5	solder\$3 with paste with (reference referring) and detect\$3 same position and mounting same (land pad) same printing	USPAT; EPO; JPO	OR	ON	2004/04/02 14:22
S6	6	solder\$3 with paste with (reference referring) and detect\$3 same position and mounting with component and (land pad) same printing	USPAT; EPO; JPO	OR	ON	2004/04/02 14:23
S7	8	solder\$3 with paste with (reference referring) and detect\$3 same position and mounting and (land pad) and printing	USPAT; EPO; JPO	OR	ON	2004/04/02 14:24
S8	11	solder\$3 with paste with (reference referring) and detect\$3 same position and mounting and printing	USPAT; EPO; JPO	OR	ON	2004/04/02 14:35
S9	1	solder\$3 with paste with (reference referring) and detect\$3 same position and self\$1alignment	USPAT; EPO; JPO	OR	ON	2004/04/02 14:35

S10	2	solder\$3 with paste with (reference referring) and detect\$3 and position and self\$1alignment	USPAT; EPO; JPO	OR	ON	2004/04/02 14:36
S11	1	solder\$3 with paste with (reference referring mark marking) same detect\$3 and position and self\$1alignment	USPAT; EPO; JPO	OR	ON	2004/04/02 14:36
S12	1	solder\$3 with paste with (reference referring mark marking) same detect\$3 and (mark\$3 position location) and self\$1alignment	USPAT; EPO; JPO	OR	ON	2004/04/02 14:37
S13	2	solder\$3 with paste with (reference referring mark marking) and detect\$3 and (mark\$3 position location) and self\$1alignment	USPAT; EPO; JPO	OR	ON	2004/04/02 14:47
S14	2	solder\$3 with paste with detect\$3 and (mark\$3 position location) and self\$1alignment	USPAT; EPO; JPO	OR	ON	2004/04/02 14:49
S15	23	solder\$3 with paste with detect\$3 and (mark\$3 position location) and printing and mounting	USPAT; EPO; JPO	OR	ON	2004/04/02 15:14
S16	18	solder\$3 with paste with detect\$3 and (decid\$3 set\$4 calculat\$3) and printing and mounting	USPAT; EPO; JPO	OR	ON	2004/04/02 18:09
S17	1	"382"/\$.ccls. and solder\$3 with paste with detect\$3 and printing and mounting	USPAT; EPO; JPO	OR	ON	2005/02/03 14:22
S18	1	"73"/\$.ccls. and solder\$3 with paste with detect\$3 and printing and mounting	USPAT; EPO; JPO	OR	ON	2004/04/02 18:11
S19	4	"228"/\$.ccls. and solder\$3 with paste with detect\$3 and printing and mounting	USPAT; EPO; JPO	OR	ON	2004/04/02 18:11
S20	4	mounting with component.ti. and nobuyasu.in.	US-PGPUB; USPAT; EPO; JPO	OR	ON	2004/04/01 11:42
S21	14	detecting with mounting and solder adj paste and mounting with component and refer\$4 with position	USPAT; EPO; JPO	OR	ON	2004/03/31 18:26
S22	3	mounting with component and detecting with printing with position and solder adj paste same (land pad) and (referring reference)	USPAT; EPO; JPO	OR	ON	2004/04/01 15:00
S23	5	mounting with component and detecting with printing with position and (controler controlling) and feed with forward and (referring reference)	USPAT; EPO; JPO	OR	ON	2004/04/01 15:02